



**APPLICATIONS**

Wireless Network  
Telecom/Datacom  
Industry Control System  
Distributed Power Architectures  
Semiconductor Equipment  
Microprocessor Power Applications

**FEATURES**

- OUTPUT CURRENT UP TO 6A
- SMALL SIZE AND LOW PROFILE :  
0.80" X 0.45" X 0.22" (SMD) ; 0.9" X 0.40" X 0.20" (SIP)
- HIGH EFFICIENCY - 94% @ 3.3V FULL LOAD
- INPUT RANGE FROM 2.4VDC TO 5.5VDC
- FIXED SWITCHING FREQUENCY (300KHZ)
- SMD & SIP PACKAGES
- OUTPUT VOLTAGE PROGRAMMABLE FROM 0.75VDC TO 3.3VDC VIA EXTERNAL RESISTOR
- INPUT UNDER-VOLTAGE LOCKOUT
- UL60950-1, EN60950-1 AND IEC60950-1 LICENSED
- ISO9001 CERTIFIED MANUFACTURING FACILITIES
- COMPLIANT TO RoHS EU DIRECTIVE 2002/95/EC

**OPTIONS**

Positive Logic Remote on/off

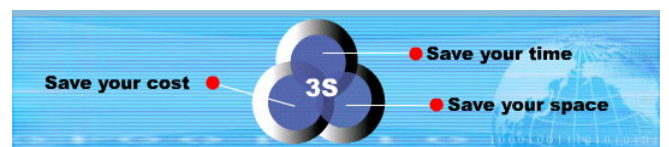
**DESCRIPTION**

DOS06-05T (SMD type), DOH06-05T (for Vertical Mounting SIP type) and DOH06-05TA (for Horizontal Mounting SIP type) are non-isolated DC/DC converters that can deliver up to 6A of output current with full load efficiency of 94% at 3.3V output.

**TECHNICAL SPECIFICATION** All specifications are typical at nominal input, full load and 25°C otherwise noted

OUTPUT SPECIFICATIONS	
Output current	6A max.
Voltage accuracy	Full load and Vin(nom.) ± 2%Vo(set)
Minimum load	0%
Line regulation	Vin=Vo(set)+0.5V to Vin(max.) at Full Load ± 0.3%Vo(set),typ.
Load regulation	No Load to Full Load ± 0.4%Vo(set),typ.
Ripple and noise (Note2)	20MHz bandwidth 20mVrms,max. 50mVp-p,max.
Temperature coefficient	±0.4%, typ.
Dynamic load response (Note2)	ΔIo / Δt = 2.5A/μS ,Vin(nom.) Peak deviation 130mV,typ.
	Load change step (50% to 100% or 100% to 50% of Io(max.)) Setting time (Vo<10%peak deviation) 25μS,typ.
Dynamic load response (Note3)	ΔIo / Δt = 2.5A/μS ,Vin(nom.) Peak deviation 50mV,typ.
	Load change step (50% to 100% or 100% to 50% of Io(max.)) Setting time (Vo<10%peak deviation) 50μS,typ.
Output current limit	220%,typ.
Output short-circuit current	Hiccup, automatics recovery
External load capacitance	ESR ≥ 1mΩ 1000μF,max.
	ESR ≥ 10mΩ 3000μF,max.
Output voltage overshoot-startup	Vin=2.4~5.5V, F.L. 1%Vo(set)
Voltage adjustability (see fig.1)	(Note 4) 0.7525V ~ 3.63V
GENERAL SPECIFICATIONS	
Efficiency	See table
Isolation voltage	None
Switching frequency	300KHz, typ.
Approvals and standard	IEC60950-1, UL60950-1, EN60950-1
Dimensions	SMD 0.80 X 0.45 X 0.22 Inch (20.3 X 11.4 X 5.5 mm)
	SIP 0.90 X 0.40 X 0.20 Inch (22.9 X 10.2 X 5.0 mm)
Weight	2.8g(0.1oz)
MTBF (Note 1)	BELLCORE TR-NWT-000332 2.133 x 10 <sup>7</sup> hrs
	MIL-HDBK-217F 3.247 x 10 <sup>6</sup> hrs

INPUT SPECIFICATIONS	
Input voltage range	Vo(set) < Vin - 0.5V 2.4 - 5.5VDC
Maximum input current	Vin=Vin(min.); Vo(set)=3.3V; Io=Io(max.) 6A
Input filter (Note 5)	C filter
Input no load current (Vin=5V, Io=0, module enabled)	Vo(set) =0.75Vdc 20mA,typ.
	Vo(set) =3.3Vdc 45mA,typ.
Input under voltage lockout	Start-up voltage 2.2V,typ.
	Shutdown voltage 2.0V,typ.
Input reflected ripple current	5~20MHz, 1μH source impedance 35mA <sub>p-p</sub>
ENVIRONMENTAL SPECIFICATIONS	
Operating ambient temperature	-40°C ~ +85°C(with derating)
Storage temperature range	-55°C ~ +125°C
Thermal shock	MIL-STD-810F
Over temperature protection	135 °C, typ.
FEATURE SPECIFICATIONS	
Remote ON/OFF(Note 6) (Negative logic)(standard)	ON = 0V < Vr < 0.3V I <sub>IN</sub> =10μA, max.
	OFF =1.5V < Vr < Vin(max) I <sub>IN</sub> =1mA, max.
(Positive logic)(option)	ON = Vin(max) I <sub>IN</sub> =10μA, max.
	OFF=0V < Vr < 0.3V I <sub>IN</sub> =1mA, max.
Input current of Remote control pin	10μA~1.0mA
Remote off state input current	Nominal Vin 0.6mA,typ.
Rise time	Time for Vo to rise from 10% to 90%of Vo(set) 6ms,max.
Turn-on delay time	Case 1 (Note 7) 1ms, typ.
	Case 2 (Note 8) 1ms, typ.





Model Name	ON/OFF Logic	Package	Input Voltage	Output Voltage	Output Current		Efficiency (%) 5.0Vin, 3.3Vdc@6A
					Min. Load	Max. Load	
DOS06-05T	Negative	SMD	2.4 ~ 5.5Vdc Vin(min.)=Vo(set)+0.5V	0.75 ~ 3.3Vdc	0A	6A	94%
DOS06-05T-P	Positive						
DOH06-05T	Negative	Vertical Mounting					
DOH06-05T-P	Positive	SIP					
DOH06-05TA	Negative	Horizontal Mounting					
DOH06-05TA-P	Positive	SIP					

Note

- BELLCORE TR-NWT-000332. Case 1: 50% Stress, Temperature at 40°C.  
MIL-HDBK-217F Notice2 @Ta=25 °C, Full load(Ground, Benign, controlled environment).
- External with C<sub>out</sub> = 1μF ceramic//10μF tantalum capacitors.
- External with C<sub>out</sub> = 2x150uF polymer capacitors.
- Output voltage programmable from 0.75V to 3.3V by connecting a single resistor (shown as R<sub>trim</sub> in Table 1) between the TRIM and GND pins of the module.To calculate the value of the resistor **R<sub>trim</sub>** for a particular output voltage **V<sub>o</sub>**, use the following equation:

$$R_{trim} = \left[ \frac{21070}{V_o - 0.7525} - 5110 \right] \Omega$$

- It's necessary to equip the external input capacitors at the input of the module. The capacitors should connect as close as possible to the input terminals that ensuring module stability. The external C<sub>in</sub> is 2x150μF low-ESR polymer capacitors // 2x47μF ceramic capacitors at least.
- Device code with suffix “-P” – Positive logic(On/Off is open collector/drain logic input; Signal referenced to GND )  
Device code with no suffix – Negative logic (On/Off pin is open collector/drain logic input with external pull –up resistor; signal referenced to GND)
- Case 1 :On/Off input is set to logic low (module on) and then input power is applied (delay from instant at which Vin=Vin(min) until Vo=10% of Vo(set))
- Case 2 :Input power is applied for at least one second and then the On/Off input is set to logic low (delay form instant at which Von/off=0.3V until Vo=10% of Vo(set))

**CAUTION:** This power module is not internally fused. An input line fuse must always be used.

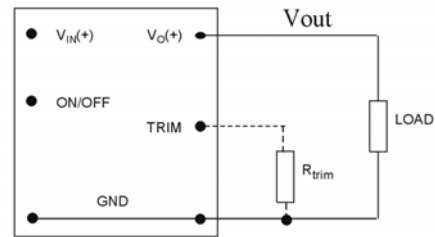
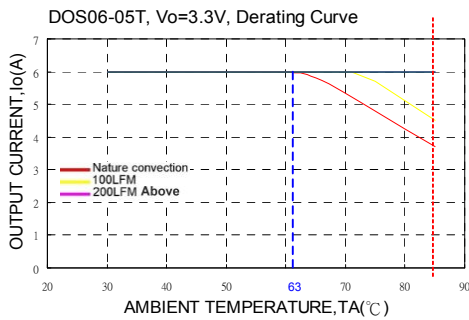
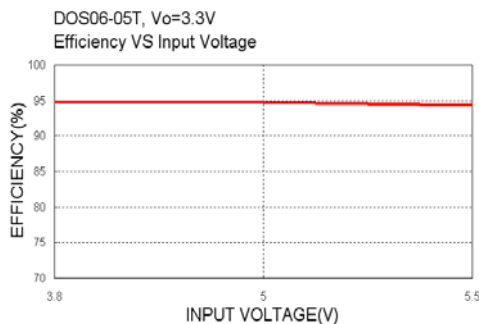
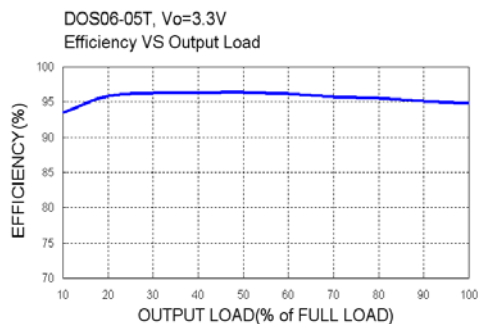


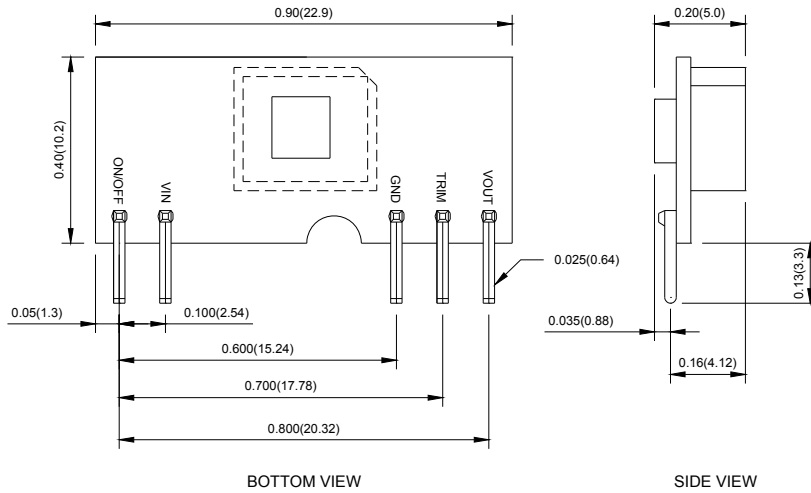
Fig. 1



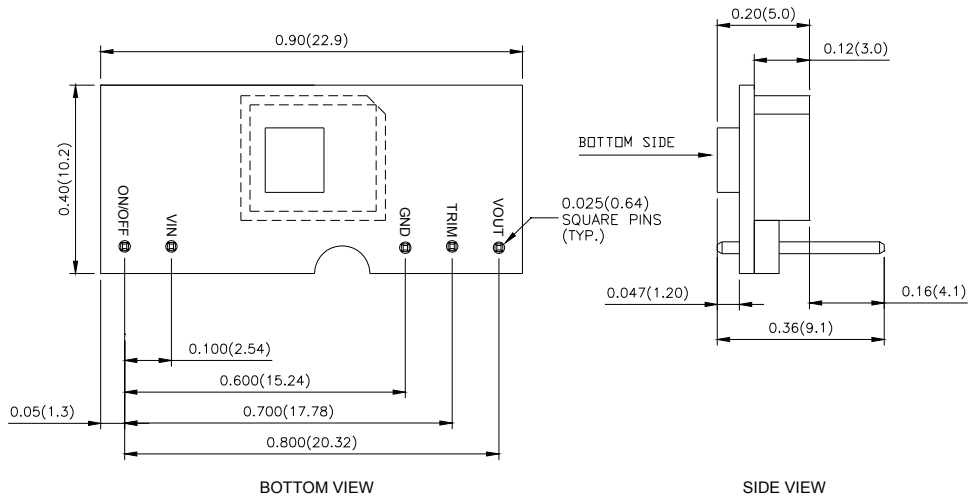
V <sub>o</sub> (set) (V)	R <sub>trim</sub> (KΩ)
0.7525	Open
1.2	41.973
1.5	23.077
1.8	15.004
2.5	6.974
3.3	3.160



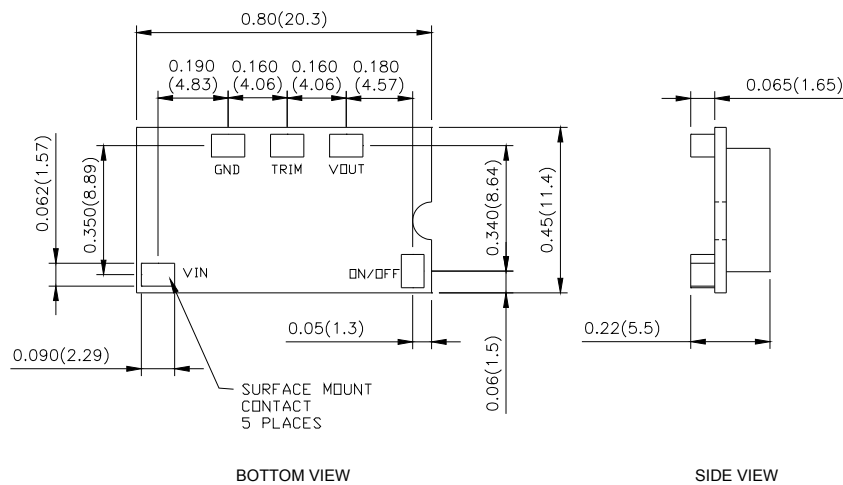
**DOH06-05T**



**DOH06-05TA**



**DOS06-05T**



1. All dimensions in Inches (mm)  
Tolerance: X.XX±0.02 (X.X±0.5)  
X.XXX±0.01 (X.XX±0.25)
2. Pin pitch tolerance ±0.01(0.25)
3. Pin dimension tolerance ±0.004 (0.1)